PATENT

Docket No. JCLA8166

Page 1

10/078316 10/078316 02/15/02

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

. CCU

Transmitted herewith for filing is the patent application of

Inventors: Jen-Jiann Chiou; Pei-Humg Chu

For: VIA HOLE DEFINING PROCESS PERFORMED IN ONE CHAMBER

Enclos	ed are:
\boxtimes	Specification 9 pages.
\boxtimes	4 Sheets of drawings
\boxtimes	Recordation Form Cover sheet with 2 pages assignment.
	A certified copy of Taiwan Patent Application No dated
\boxtimes	SIGNED declaration and power of attorney.
\boxtimes	Return Prepaid postcard.

CLAIMS AS FILED									
FOR	NUMB	ER FII	ED N	NUMBEI	REXTRA	RATE	FEE		
Basic Fee						\$740.00	\$740.00		
Total Claims	23	_	20 =	3	×	\$18.00	\$54.00		
Independent Claims	2	_	3 =	0	×	\$84.00	\$0.00		
If application contains any multiple dependent claim (s), then add \$280.00									
	TOTAL I	TLING	FEE				\$794.00		

A check in the amount of \$794.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

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Assistant Commissioner for Patents Washington, D.C. 20231

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA8166

Applicant(s) : Jen-Jiann Chiou; Pei-Humg Chu

For : VIA HOLE DEFINING PROCESS

PERFORMED IN ONE CHAMBER

"Express Mail" : EV 016847615 US

Mailing Label No.

Date of Deposit : Feb. 15, 2002

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 9 pages, 4 sheets of drawings; SIGNED Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents. Washington, D.C. 20231.

M. Chang Michelle Chang